DESCRIPTION

The MP8860 is a synchronous, 4-switch, integrated buck-boost converter capable of regulating the output voltage from a 2.8V to 22V wide input voltage range with high efficiency.

The MP8860 uses constant-on-time (COT) control in buck mode and constant-off-time control in boost mode, providing fast load transient response and smooth buck-boost mode transient. The MP8860 provides auto PFM/PWM or forced PWM switching modes, and programmable output constant current (CC) current limit, which supports flexible design for different applications.

Full protection features include over-current protection (OCP), over-voltage protection (OVP), under-voltage protection (UVP), programmable soft start, and thermal shutdown.

The MP8860 is available in a 16-pin QFN (3mmx3mm) package.

FEATURES

- Wide 2.8V to 22V Operating Input Voltage Range
- 1V (1) to 20.47V Output Voltage Range (5V Default) with 10mV Resolution through I²C
- 1A Output Current or 4A Input Current
- Four Low \( R_{\text{DS(on)}} \) Internal Buck Power MOSFETs
- Adjustable Accurate CC Output Current Limit with Internal Sensing MOSFET via I²C
- 500kHz Switching Frequency
- Output Over-Voltage Protection (OVP) Hiccup
- Output Short-Circuit Protection (SCP) with Hiccup
- Over-Temperature Warning and Shutdown
- I²C Interface with ALT Pin
- Four Programmable I²C Addresses
- One-Time Programmable (OTP) Non-Volatile Memory
- I²C Programmable Line Drop Compensation, PFM/PWM Mode, Soft Start, OCP, etc.
- EN Shutdown Discharge Programmable
- Available in a QFN-16 (3mmx3mm) Package

APPLICATIONS

- Power Supply for Motor
- Buck-Boost Bus Supplies
- Industrial Systems
- Personal Medical Products
- DSLR Cameras

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance. “MPS”, the MPS logo, and “Simple, Easy Solutions” are registered trademarks of Monolithic Power Systems, Inc. or its subsidiaries.

NOTE:
1) For \( V_{\text{OUT}} < 3V \) applications, the switching frequency decreases.
TYPICAL APPLICATION

Efficiency vs. Output Current

Vin = 12V, Vout = 5 - 20V, L = 4.7μH, DCR = 19.5mΩ, Forced PWM Mode

- Vout=5V
- Vout=9V
- Vout=12V
- Vout=20V
ORDERING INFORMATION

<table>
<thead>
<tr>
<th>Part Number*</th>
<th>Package</th>
<th>Top Marking</th>
</tr>
</thead>
<tbody>
<tr>
<td>MP8860GQ-xxxx**</td>
<td>QFN-16 (3mmx3mm)</td>
<td><strong>See Below</strong></td>
</tr>
<tr>
<td>MP8860GQ-0000</td>
<td>QFN-16 (3mmx3mm)</td>
<td></td>
</tr>
<tr>
<td>EVKT-MP8860</td>
<td>Evaluation Kit</td>
<td></td>
</tr>
</tbody>
</table>

* For Tape & Reel, add suffix –Z (e.g. MP8860GQ-XXXX–Z).

** “xxxx” is the configuration code identifier for the register setting stored in the OTP. The default number is “0000”. Each “x” can be a hexadecimal value between 0 and F. Please work with an MPS FAE to create this unique number, even if ordering the “0000” code. MP8860GQ-0000 is the default version.

TOP MARKING

BJRY
LLL

BJR: Product code of MP8860GQ
Y: Year code
LLL: Lot number

EVALUATION KIT EVKT-MP8860

EVKT-MP8860 kit contents: (Items below can be ordered separately).

<table>
<thead>
<tr>
<th>#</th>
<th>Part Number</th>
<th>Item</th>
<th>Quantity</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>EV8860-Q-00A</td>
<td>MP8860GQ-0000 evaluation board</td>
<td>1</td>
</tr>
<tr>
<td>2</td>
<td>EVKT-USBI2C-02</td>
<td>Includes one USB to I²C communication interface device, one USB cable, and one ribbon cable</td>
<td>1</td>
</tr>
</tbody>
</table>

Order direct from MonolithicPower.com or our distributors.

Figure 1: EVKT-MP8860 Evaluation Kit Set-Up
### PIN FUNCTIONS

<table>
<thead>
<tr>
<th>QFN 3x3 Pin #</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>IN</td>
<td><strong>Supply voltage.</strong> IN is the drain of the internal power device and provides power to the entire chip. The MP8860 operates from a 2.8V to 22V input voltage. A capacitor (C_{IN}) is required to prevent large voltage spikes from appearing at the input. Place C_{IN} as close to the IC as possible.</td>
</tr>
<tr>
<td>2, 11</td>
<td>GND</td>
<td><strong>Power ground.</strong> GND is the reference ground of the regulated output voltage. GND requires extra care during PCB layout. Connect GND with copper traces and vias.</td>
</tr>
<tr>
<td>3</td>
<td>EN</td>
<td><strong>On/off control for entire chip.</strong> Drive EN high to turn on the chip. Drive EN low or float EN to turn off the device. EN has internal 2MΩ pull-down resistor to ground.</td>
</tr>
<tr>
<td>4</td>
<td>ADD</td>
<td><strong>I^2C slave addresses program pin.</strong> Connect a resistor divider from VCC to ADD to set four different I^2C slave addresses.</td>
</tr>
<tr>
<td>5</td>
<td>SCL</td>
<td><strong>Clock pin of the I^2C interface.</strong> SCL can support an I^2C clock up to 3.4MHz.</td>
</tr>
<tr>
<td>6</td>
<td>SDA</td>
<td><strong>Data pin of the I^2C interface.</strong></td>
</tr>
<tr>
<td>7</td>
<td>OC</td>
<td><strong>Output constant current limit set pin.</strong></td>
</tr>
<tr>
<td>8</td>
<td>ALT</td>
<td><strong>Alert output.</strong> ALT pulling to logic low indicates that a fault or warning has occurred.</td>
</tr>
<tr>
<td>9</td>
<td>VCC</td>
<td><strong>Internal 3.6V LDO regulator output.</strong> Decouple VCC with a 1µF capacitor.</td>
</tr>
<tr>
<td>10</td>
<td>AGND</td>
<td><strong>Analog ground.</strong> Connect AGND to GND.</td>
</tr>
<tr>
<td>12</td>
<td>OUT</td>
<td><strong>Output power pin.</strong> Place the output capacitor close to OUT and GND.</td>
</tr>
<tr>
<td>13</td>
<td>BST2</td>
<td><strong>Bootstrap.</strong> Connect a 0.1µF capacitor between SW2 and BST2 to form a floating supply across the high-side switch driver.</td>
</tr>
<tr>
<td>14</td>
<td>SW2</td>
<td><strong>Switching node of the second half bridge.</strong> Connect one end of the inductor to SW2 for the current to run through the bridge.</td>
</tr>
<tr>
<td>15</td>
<td>SW1</td>
<td><strong>Switching node of the first half bridge.</strong> Connect one end of the inductor to SW1 for the current to run through the bridge.</td>
</tr>
<tr>
<td>16</td>
<td>BST1</td>
<td><strong>Bootstrap.</strong> Connect a 0.1µF capacitor between SW1 and BST1 to form a floating supply across the high-side switch driver.</td>
</tr>
</tbody>
</table>
**ABSOLUTE MAXIMUM RATINGS** (2)

Supply voltage \( (V_{\text{IN}}, V_{\text{OUT}}) \) ................................. 24V

\( V_{\text{SW1}, \text{SW2}} \) ............................ -0.3V (-7V for <10ns)

to \( V_{\text{IN}} + 0.3V \) (26V for <10ns)

\( V_{\text{BST1}, \text{BST2}} \) .................. \( V_{\text{SWx}} + 4V \) (\( V_{\text{SWx}} + 5V < 10\text{ns} \))

\( V_{\text{EN}} \) .................................. -0.3V to 24V

\( V_{\text{ALT}} \) ................................ -0.3V to +5.5V

All other pins ................................ -0.3V to +4V

Continuous power dissipation \( (T_A = +25^\circ\text{C}) \) (3)(5) .................................. 4.8W

Junction temperature ............................. 150°C

Lead temperature ................................. 260°C

Storage temperature ............................ -65°C to +150°C

**Recommended Operating Conditions** (4)

Operation input voltage range ........... 2.8V to 22V

Output voltage range ....................... 1V to 20.47V

Output current ..................... 1A continuous current or 4A input current

Operating junction temp. \( (T_J) \) .......................... -40°C to +125°C

---

**Thermal Resistance** \( \theta_{JA} \) \( \theta_{JC} \)

QFN-16 (3mmx3mm)

EV8860-Q-00A (5) .................. 26 .... 3 .... °C/W

JESD51-7 (6) .......................... 50 .... 12 .... °C/W

**NOTES:**

2) Exceeding these ratings may damage the device.

3) The maximum allowable power dissipation is a function of the maximum junction temperature \( T_J \) (MAX), the junction-to-ambient thermal resistance \( \theta_{JA} \), and the ambient temperature \( T_A \). The maximum allowable continuous power dissipation at any ambient temperature is calculated by \( P_{D(\text{MAX})} = (T_J \text{ (MAX)} - T_A) / \theta_{JA} \). Exceeding the maximum allowable power dissipation produces an excessive die temperature, and the regulator goes into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.

4) The device is not guaranteed to function outside of its operating conditions.

5) Measured on EV8860-Q-00A, 4-layer PCB, 64mmx64mm.

6) Measured on JESD51-7, 4-layer PCB. The value of \( \theta_{JA} \) given in this table is only valid for comparison with other packages and cannot be used for design purposes. These values were calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application.
# OTP E-Fuse Selection Table by Default (MP8860GQ-0000)

<table>
<thead>
<tr>
<th>OTP Items</th>
<th>Default Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Output voltage</td>
<td>5V</td>
</tr>
<tr>
<td>IOUT_LIMIT</td>
<td>2A (For 21.5kΩ OC resistor)</td>
</tr>
<tr>
<td>Switching frequency</td>
<td>500kHz</td>
</tr>
<tr>
<td>Mode</td>
<td>Forced PWM mode</td>
</tr>
<tr>
<td>Soft-start time</td>
<td>900μs</td>
</tr>
<tr>
<td>Line drop compensation</td>
<td>No line drop compensation</td>
</tr>
<tr>
<td>Output voltage discharge mode</td>
<td>Enabled</td>
</tr>
<tr>
<td>OCP_OVP protection mode</td>
<td>Hiccup</td>
</tr>
<tr>
<td>OTP configure code (ID1)</td>
<td>0x00</td>
</tr>
</tbody>
</table>
## ELECTRICAL CHARACTERISTICS

$V_{IN} = 12V$, $V_{EN} = 5V$, $T_J = -40^\circ C$ to $+125^\circ C$ \(^{(7)}\), typical value is tested at $T_J = +25^\circ C$, unless otherwise noted.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply current (shutdown)</td>
<td>$I_{IN}$</td>
<td>$V_{EN} = 0V$</td>
<td>0</td>
<td>3</td>
<td></td>
<td>$\mu A$</td>
</tr>
<tr>
<td>Supply current (quiescent)</td>
<td>$I_Q$</td>
<td>Non-switching, I2C sets PFM mode</td>
<td>1</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>EN rising threshold</td>
<td>$V_{EN_{Rising}}$</td>
<td></td>
<td>1.00</td>
<td>1.10</td>
<td>1.20</td>
<td>V</td>
</tr>
<tr>
<td>EN hysteresis</td>
<td>$V_{EN_{Hysteresis}}$</td>
<td></td>
<td>65</td>
<td>110</td>
<td>160</td>
<td>mV</td>
</tr>
<tr>
<td>EN to ground resistance</td>
<td>$R_{EN}$</td>
<td>$V_{EN} = 2V$</td>
<td>2</td>
<td></td>
<td></td>
<td>M$\Omega$</td>
</tr>
<tr>
<td>EN on to $V_{OUT} &gt; 90%$ delay</td>
<td>$T_{Delay}$</td>
<td>See Figure 8.</td>
<td>900</td>
<td></td>
<td></td>
<td>$\mu$s</td>
</tr>
<tr>
<td>VCC regulator</td>
<td>$V_{CC}$</td>
<td></td>
<td>3.3</td>
<td>3.65</td>
<td>4</td>
<td>V</td>
</tr>
<tr>
<td>VCC load regulation</td>
<td>$V_{CC_{LOAD}}$</td>
<td>$I_{CC} = 10mA$</td>
<td>1</td>
<td></td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>$V_{IN}$ under-voltage lockout threshold rising</td>
<td>$V_{IN_{UVLO}}$</td>
<td></td>
<td>2.50</td>
<td>2.65</td>
<td>2.8</td>
<td>V</td>
</tr>
<tr>
<td>$V_{IN}$ under-voltage lockout threshold hysteresis</td>
<td>$V_{UVLO_{HYS}}$</td>
<td></td>
<td>95</td>
<td>160</td>
<td>205</td>
<td>mV</td>
</tr>
</tbody>
</table>

### Power Converter

- **HS switch on resistance**: $R_{DS_{ON, HS}}$, Switch A, D
  - Min: 50 m$\Omega$
  - Typ: 80 m$\Omega$
- **LS switch on resistance**: $R_{DS_{ON, LSB}}$, Switch B, C
  - Min: 42 m$\Omega$
  - Typ: 70 m$\Omega$
- **Output voltage**: $V_{OUT}$
  - Min: -1.5%
  - Typ: 5.0
  - Max: +1.5%
  - Units: V
- **Output discharge resistance**: $R_{DIS}$
  - Min: 60 $\Omega$
  - Typ: 100 $\Omega$
- **Switch leakage**: $SW_{LKG}$
  - $V_{EN} = 0V$, $V_{SW1, SW2} = 22V$, $T_J = +25^\circ C$
  - $V_{EN} = 0V$, $V_{SW1, SW2} = 22V$, $T_J = -40^\circ C$ to $+125^\circ C$
  - Min: 1 $\mu A$
  - Typ: 5 $\mu A$
- **Oscillator frequency**: $F_s$
  - $T_J = +25^\circ C$
  - Min: -20%
  - Typ: 530
  - Typ: 20%
  - Units: kHz
- **Minimum on time** \(^{(8)}\): $T_{ON_{MIN1}}$, Switch A, B, C, D
  - Min: 160 ns
- **Maximum duty cycle**: $D_{MAX}$, Buck mode, FREQ = 500kHz
  - Min: 85%
- **Minimum duty cycle** \(^{(8)}\): $D_{MIN}$, Boost mode, FREQ = 500kHz
  - Min: 15%

### Protection

- **Output over-voltage protection**: $V_{OVP_R}$
  - Min: 150 V
  - Typ: 160 V
  - Max: 170 V
  - Units: %
- **Output OVP recovery**: $V_{OVP_F}$
  - Min: 130 V
  - Typ: 140 V
  - Max: 150 V
  - Units: %
- **Low-side B valley limit**: $I_{LIMIT2}$, Switch B
  - Min: 6 A
  - Typ: 8 A
  - Max: 10 A
- **Low-side C peak current limit**: $I_{LIMIT3}$, Switch C
  - Min: 10 A
- **Output average current** \(^{(8)}\): $I_{OUT_{LIM1}}$, $V_{OUT} = 5V$, over 0-125°C temp range
  - Min: 0.85 A
  - Max: 1.15 A
- **Output average current** \(^{(8)}\): $I_{OUT_{LIM2}}$, $V_{OUT} = 5V$, over 0-125°C temp range
  - Min: -5 A
  - Max: +5 A
- **Output UV threshold**: $V_{UVP}$
  - Min: 45%
  - Typ: 50%
  - Max: 55%
  - Units: $V_{REF}$
### ELECTRICAL CHARACTERISTICS (continued)

VIN = 12V, VEN = 5V, TJ = -40°C to +125°C (7), typical value is tested at TJ = +25°C, unless otherwise noted.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>ALT sink current capability</td>
<td>ALT_LOW</td>
<td>Sink 4mA</td>
<td>0.2</td>
<td>0.4</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>ALT leakage</td>
<td>ALT_LKG</td>
<td>V_PULL = 5V</td>
<td>1</td>
<td></td>
<td></td>
<td>μA</td>
</tr>
<tr>
<td>Thermal shutdown rising threshold</td>
<td>T_STD</td>
<td></td>
<td>150</td>
<td></td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td>Thermal hysteresis</td>
<td>T_STD_HYS</td>
<td></td>
<td>20</td>
<td></td>
<td></td>
<td>°C</td>
</tr>
</tbody>
</table>

### I2C Specification (8)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>ADD voltage threshold 1</td>
<td>V_ADD_1</td>
<td>ADD pin float</td>
<td>69H</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ADD voltage threshold 2</td>
<td>V_ADD_2</td>
<td>R4 = 499kΩ, R5 = 301kΩ</td>
<td>6BH</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ADD voltage threshold 3</td>
<td>V_ADD_3</td>
<td>R4 = 301kΩ, R5 = 499kΩ</td>
<td>6DH</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ADD voltage threshold 4</td>
<td>V_ADD_4</td>
<td>R4 = 100kΩ</td>
<td>6FH</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ADD to GND pull-down resistor</td>
<td>R_ADD</td>
<td></td>
<td>2</td>
<td></td>
<td></td>
<td>MΩ</td>
</tr>
<tr>
<td>Input logic high</td>
<td>V_IH</td>
<td>I2C pull-up VDD can be 1.8V to 5V</td>
<td>1.4</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Input logic low</td>
<td>V_IL</td>
<td></td>
<td>0.4</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output voltage logic low</td>
<td>V_OUT_L</td>
<td></td>
<td>0.4</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>SCL clock frequency</td>
<td>f_SCL</td>
<td></td>
<td>400</td>
<td></td>
<td>3400</td>
<td>kHz</td>
</tr>
<tr>
<td>SCL high time</td>
<td>t_HIGH</td>
<td></td>
<td>60</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>SCL low time</td>
<td>t_LOW</td>
<td></td>
<td>160</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Data set-up time</td>
<td>t_SU,DAT</td>
<td></td>
<td>10</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Data hold time</td>
<td>t_HD,DAT</td>
<td></td>
<td>0</td>
<td>60</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Set-up time for (repeated) start condition</td>
<td>t_SU,STA</td>
<td></td>
<td>160</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Hold time for (repeated) start condition</td>
<td>t_HD,STA</td>
<td></td>
<td>160</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Bus free time between a start and a stop condition</td>
<td>t_BUF</td>
<td></td>
<td>160</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Set-up time for stop condition</td>
<td>T_SU,STO</td>
<td></td>
<td>160</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Rise time of SCL and SDA</td>
<td>t_R</td>
<td></td>
<td>10</td>
<td>300</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Fall time of SCL and SDA</td>
<td>t_F</td>
<td></td>
<td>10</td>
<td>300</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Pulse width of suppressed spike</td>
<td>t_SP</td>
<td></td>
<td>0</td>
<td>50</td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>Capacitance for each bus line</td>
<td>C_B</td>
<td></td>
<td></td>
<td></td>
<td>400</td>
<td>pF</td>
</tr>
</tbody>
</table>

**NOTES:**

7) All min/max parameters are tested at TJ = 25°C. Limits over temperature are guaranteed by design, characterization, and correlation.

8) Guaranteed by engineering sample characterization.
TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN} = 12V$, $V_{OUT} = 5V$, $L = 4.7\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

Output Voltage vs. Temperature

Output Voltage UVP Threshold vs. Temperature

$V_{IN}$ UVLO Rising and Falling Threshold vs. Temperature

EN Rising and Falling Threshold vs. Temperature
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

\(V_{\text{IN}} = 12\, \text{V}, V_{\text{OUT}} = 5\, \text{V}, L = 4.7\, \mu\text{H}, T_{\text{A}} = 25^\circ\, \text{C},\) unless otherwise noted.

**Load Regulation vs. Output Current**

\(V_{\text{IN}} = 12\, \text{V}, V_{\text{OUT}} = 5\, \text{V}/9\, \text{V}/12\, \text{V}/20\, \text{V}, I_{\text{OUT}} = 0\, \text{A} \text{ to } 1\, \text{A}, \text{No Line Drop Compensation}

**Line Regulation vs. Input Voltage**

\(V_{\text{IN}} = 3\, \text{V} \text{ to } 22\, \text{V}, V_{\text{OUT}} = 5\, \text{V}, I_{\text{OUT}} = 0\, \text{A} \text{ to } 1\, \text{A}

**Line Regulation vs. Input Voltage**

\(V_{\text{IN}} = 3\, \text{V} \text{ to } 22\, \text{V}, V_{\text{OUT}} = 9\, \text{V}, I_{\text{OUT}} = 0\, \text{A} \text{ to } 1\, \text{A}

**Line Regulation vs. Input Voltage**

\(V_{\text{IN}} = 3\, \text{V} \text{ to } 22\, \text{V}, V_{\text{OUT}} = 12\, \text{V}, I_{\text{OUT}} = 0\, \text{A} \text{ to } 1\, \text{A}

**Thermal Rising vs. Output Current**

\(V_{\text{IN}} = 12\, \text{V}, V_{\text{OUT}} = 5\, \text{V}, I_{\text{OUT}} = 0\, \text{A} \text{ to } 1\, \text{A}

**Thermal Rising vs. Output Current**

\(V_{\text{OUT}} = 5\, \text{V} \text{ and } 9\, \text{V}

**Thermal Rising vs. Output Current**

\(V_{\text{OUT}} = 5\, \text{V} \text{ and } 9\, \text{V} \)
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

\( V_{IN} = 12V \), \( V_{OUT} = 5V \), \( L = 4.7\mu H \), \( T_A = 25^\circ C \), unless otherwise noted.

Efficiency vs. Output Current

\( V_{IN} = 12V \), \( V_{OUT} = 5 \text{ - } 20V \), \( L = 4.7\mu H \), \( DCR = 19.5m\Omega \), Forced PWM Mode
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$V_{IN} = 12V$, $V_{OUT} = 5V$, $L = 4.7\mu H$, $T_A = 25^\circ C$, test waveform is based on Figure 13, unless otherwise noted.

**ENPWR Bit Enable through I$^2$C Command**

Load = 0A

**ENPWR Bit Disable through I$^2$C Command**

Load = 0A

**V$_{IN}$ Power Off**

Load = 0A

**V$_{IN}$ Power Off**

Load = 1A
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

\( V_{IN} = 12\, \text{V}, \quad V_{OUT} = 5\, \text{V}, \quad L = 4.7\, \mu\text{H}, \quad T_A = 25^\circ\text{C} \), test waveform is based on Figure 13, unless otherwise noted.

**Vin Start-Up**
- **Load = 10mA**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 10V/div.
- CH4: \( I_L \) 5A/div.
- 400\( \mu \)s/div.

**Vin Start-Up**
- **Load = 1A**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 20V/div.
- CH4: \( I_L \) 5A/div.
- 400\( \mu \)s/div.

**EN Pin Enable**
- **Load = 0A**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 10V/div.
- CH4: \( I_L \) 5A/div.
- 400\( \mu \)s/div.

**EN Pin Enable**
- **Load = 1A**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 20V/div.
- CH4: \( I_L \) 5A/div.
- 400\( \mu \)s/div.

**EN Pin Disable**
- **Load = 0A**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 5V/div.
- CH4: \( I_L \) 5A/div.
- 2ms/div.

**EN Pin Disable**
- **Load = 1A**
- CH1: \( V_{OUT} \) 5V/div.
- CH2: \( V_{SW1} \) 10V/div.
- CH3: \( V_{SW2} \) 20V/div.
- CH4: \( I_L \) 1A/div.
- 2ms/div.
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$V_{IN} = 12V$, $V_{OUT} = 5V$, $L = 4.7\mu H$, $T_A = 25^\circ C$, test waveform is based on Figure 13, unless otherwise noted.

Steady State
$V_{OUT} = 5V$, Load = 0A

Steady State
$V_{OUT} = 5V$, Load = 1A

Steady State
$V_{OUT} = 9V$, Load = 0A

Steady State
$V_{OUT} = 9V$, Load = 1A

Steady State
$V_{OUT} = 12V$, Load = 0A

Steady State
$V_{OUT} = 12V$, Load = 1A
MP8860 – 22V \( V_{IN} \), 1A \( I_{OUT} \), INTEGRATED BUCK-BOOST WITH I2C INTERFACE

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

\( V_{IN} = 12V, \ V_{OUT} = 5V, \ L = 4.7\mu H, \ T_a = 25^\circ C \), test waveform is based on Figure 13, unless otherwise noted.

**Load Transient**
\( V_{IN} = 12V, \ V_{OUT} = 5V, \) No Line Drop Compensation, 0A to 1A, 150mA/\( \mu s \)

![Load Transient](image1)

**Load Transient**
\( V_{IN} = 12V, \ V_{OUT} = 5V, \) No Line Drop Compensation, 0A to 0.5A, 150mA/\( \mu s \)

![Load Transient](image2)

**OCP Entry**
\( V_{IN} = 12V, \ V_{OUT} = 5V, \) Latch-Off Mode

![OCP Entry](image3)

**OCP Entry**
\( V_{IN} = 12V, \ V_{OUT} = 5V, \) Hiccup Mode

![OCP Entry](image4)

**OCP Recovery**
\( V_{IN} = 12V, \ V_{OUT} = 5V, \) Hiccup Mode

![OCP Recovery](image5)
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, $L = 4.7\mu\text{H}$, $T_A = 25^\circ\text{C}$, test waveform is based on Figure 13, unless otherwise noted.

**SCP Entry**

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, Latch-Off Mode

**SCP Recovery**

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, Hiccup Mode

**SCP Steady**

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, Hiccup Mode

**CC Steady**

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, Hiccup Mode

**CC Entry**

$V_{IN} = 12\text{V}$, $V_{OUT} = 5\text{V}$, Hiccup Mode
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VIN = 12V, VOUT = 5V, L = 4.7µH, TA = 25°C, test waveform is based on Figure 13, unless otherwise noted.

**OVP**

VIN = 12V, VOUT = 5V, IOUT = 0A, Latch-Off Mode

CH1: VOUT 5V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

400ms/div.

**OVP**

VIN = 12V, VOUT = 5V, IOUT = 0A, Hiccup Mode

CH1: VOUT 5V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

400ms/div.

**I²C VID**

VIN = 12V, VOUT = 5V to 12V, IOUT = 0A

CH1: VOUT 10V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

20ms/div.

**I²C VID**

VIN = 12V, VOUT = 12V to 5V, IOUT = 0A

CH1: VOUT 10V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

20ms/div.

**I²C VID**

VIN = 12V, VOUT = 5V to 12V, IOUT = 1A

CH1: VOUT 10V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

20ms/div.

**I²C VID**

VIN = 12V, VOUT = 12V to 5V, IOUT = 1A

CH1: VOUT 10V/div.
CH2: VSW1 10V/div.
CH3: VSW2 10V/div.
CH4: IL 5A/div.

20ms/div.
Figure 2: Functional Block Diagram
OPERATION
The MP8860 is a 4-switch, integrated buck-boost converter that can work in constant-on-time (COT) mode with fixed frequency, which provides fast transient response for the buck, boost, and buck-boost modes. One special buck-boost control strategy provides high efficiency over the full input range and smooth transient between different modes.

Buck-Boost Operation
The MP8860 can regulate the output to be above, equal to, or below the input voltage. Based on the one inductor, 4-switch power structure (see Figure 3), the MP8860 can operate in buck mode, boost mode, or buck-boost mode with different $V_{IN}$ inputs (see Figure 4).

Boost Mode ($V_{IN} < V_{OUT}$)
When the input voltage is significantly lower than the output voltage, the MP8860 works in boost mode. In boost mode, SWC and SWD are switching for the boost regulation. SWB is off, and SWA remains on to conduct the inductor current.

SWC remains off with COT control in each period, while SWD turns on as a complement of SWC to boost the inductor current to the output. In each cycle, SWC turns on to conduct the inductor current. When the inductor current rises and reaches $V_{COMP}$, SWC turns off and SWD turns on. SWC turns off with a fixed off-time before turning on again. During this period, SWD turns on for the current freewheel (see Figure 6).

Buck-Boost Mode ($V_{IN} \approx V_{OUT}$)
When $V_{IN}$ is close to $V_{OUT}$, the converter cannot provide enough energy to operate in buck mode due to SWA’s minimum off-time, or the converter supplies too much power to $V_{OUT}$ in boost mode due to SWC’s minimum on time. The MP8860 uses buck-boost control to regulate the output in these conditions.
In buck mode, if \( V_{IN} \) drops and the SWA off period is close to the buck minimum off time, the buck-boost mode is engaged. When the next cycle starts after the SWA and SWD on-time period (buck high-side MOSFET (HS-FET) on period), the boost starts with SWA and SWC on (boost low-side MOSFET (LS-FET) on). SWA and SWD turn on again for the rest period of the boost period (boost HS-FET on). After the boost period elapses, the bucket period starts, and SWB and SWD remain on until the inductor current drops to \( V_{COMP} \). Then SWA and SWD turn on until the next boost period begins. Buck and boost switching work with a one-interval period. This is called buck-boost mode.

In boost mode, if \( V_{IN} \) rises and the SWC on period is close to the boost minimum on time, buck-boost mode engages. After the boost constant-off time period (SWA and SWD on), SWB and SWD remain on until the inductor current signal drops to \( V_{COMP} \), just like a buck off-time period control. After the inductor current signal triggers \( V_{COMP} \), SWA and SWD turn on for the buck on time, which is followed by a boost switching (SWA and SWC on). Buck and boost switching work with a one-interval period. Figure 7 shows the buck-boost waveform for both \( V_{IN} > V_{OUT} \) and \( V_{IN} < V_{OUT} \).

In buck-boost mode, if \( V_{IN} \) is higher than 130% of \( V_{OUT} \), the MP8860 switches from buck-boost mode to buck mode. If \( V_{IN} \) is lower than 20% of \( V_{OUT} \), the MP8860 switches from buck-boost mode to boost mode.

**Working Mode Selection**

The MP8860 works with a fixed frequency in heavy-load condition. When the load current decreases, the MP8860 can work in forced continuous conduction mode (FCCM) or pulse-skip mode (PSM) based on the MODE register setting.

**FCCM (or Forced PWM)**

In FCCM, the buck on time and boost off time are determined by the internal circuit to achieve a fixed frequency based on the \( V_{IN}/V_{OUT} \) ratio. When the load decreases, the average input current drops, and the inductor current may go negative from \( V_{OUT} \) to \( V_{IN} \) during the off time (SWD on). This forces the inductor current to work in continuous mode with a fixed frequency, producing a lower \( V_{OUT} \) ripple than in PSM mode.

**PSM (Auto PFM/PWM Mode)**

In PSM, once the inductor current drops to 0A, SWD turns off to prevent the current from flowing from \( V_{OUT} \) to \( V_{IN} \), forcing the inductor current to work in discontinuous conduction mode (DCM). Simultaneously, the internal off-time clock stretches once the MP8860 enters DCM mode. The frequency drops when the inductor current conduction period decreases, helping to save power loss and reduce the \( V_{OUT} \) ripple.

If \( V_{COMP} \) drops to the PSM threshold, even if the IC stretches the frequency, the MP8860 stops switching to decrease more switching power loss. The MP8860 recovers switching once \( V_{COMP} \) rises above the PSM threshold. The switching pulse skips based on \( V_{COMP} \) in a very light-load condition. PSM has a much higher efficiency than FCCM mode in light load, but the \( V_{OUT} \) ripple may be higher due to the group switching pulse.

**Internal VCC Regulator**

The 3.6V internal regulator powers most of the internal circuitries. This regulator takes \( V_{IN} \) and operates in the full \( V_{IN} \) range. When \( V_{IN} \) exceeds 3.6V, the output of the regulator is in
full regulation. If $V_{IN}$ is less than 3.6V, the output decreases with $V_{IN}$. VCC requires an external 1µF ceramic capacitor for decoupling.

Enable Control (EN)
The MP8860 has an enable control pin (EN). Pull EN high to enable the IC. Pull EN low or float EN to disable the IC.

If EN is pulled down when the output discharge function is enabled, the MP8860 shuts down completely after 55ms. The MP8860’s I²C register value is reset to default only after the MP8860 shuts down completely. If EN is pulled high within 55ms, the I²C register is not reset, and the MP8860 enables the output with the previous register setting.

If the output discharge function is disabled, the MP8860 shuts down completely once EN is pulled down for more than 100µs, and the MP8860 I²C register is reset after a 100µs delay (see Figure 8).

Figure 8: EN On/Off Logic for I²C Register Reset

Under-Voltage Lockout (UVLO)
Under-voltage lockout (UVLO) protects the chip from operating at an insufficient supply voltage. The UVLO comparator monitors the input voltage and enables or disables the entire IC.

Internal Soft Start (SS)
Soft start (SS) prevents the converter output voltage from overshooting during start-up. When the chip starts up, the internal circuitry generates a SS voltage that ramps up from 0V to 3.6V. When SS is lower than REF, the error amplifier uses SS as the reference. When SS is higher than REF, the error amplifier uses REF as the reference.

If the output of the MP8860 is pre-biased to a certain voltage during start-up, the IC disables the switching of both the high-side and low-side switches until the voltage on the internal SS capacitor exceeds the internal feedback voltage (see Figure 9).

Output Constant Current Limit (OCP)
The MP8860 has a constant current limit control loop to limit the output average current. The current information is sensed from switch A, B, C, and D. Then an average algorithm is used to calculate the output current.

When the output current exceeds the current-limit threshold, the output voltage starts to drop. If $V_{OUT}$ drops below the under-voltage (UV) threshold (typically 50% below the reference), the MP8860 enters hiccup mode or latch-off mode according to the I²C setting.

In hiccup mode, the MP8860 stops switching and recovers automatically with 12.5% duty cycles. In latch-off mode, the MP8860 stops switching until the IC restarts ($V_{IN}$, EN, or EN bit toggle).

Over-Voltage Protection (OVP)
The MP8860 monitors a resistor-divided feedback voltage to detect output over-voltage. When the feedback voltage rises higher than 160% of the target voltage, the over-voltage protection (OVP) comparator output goes high, and the output-to-ground discharge resistor turns on.

The OUT pin has an absolute OVP function. Once $V_{OUT}$ is higher than the absolute OVP threshold (23V), the MP8860 stops switching and turns on the OUT-to-ground discharge resistor.

Start-Up and Shutdown
If both $V_{IN}$ and EN exceed their respective thresholds, the chip is enabled. The reference block starts first, generating a stable reference voltage and current, and then the internal regulator is enabled. The regulator provides a stable supply for the remaining circuitries.

Three events can shut down the chip: EN low, $V_{IN}$ low, and thermal shutdown. During shutdown, the signaling path is blocked to avoid any fault triggering. Then $V_{COMP}$ and the internal...
Supply rail are pulled down. The floating driver is not subject to this shutdown command.

**Output Discharge**

The MP8860 has an output discharge function that provides a resistive discharge path for the external output capacitor. The function is active when the part is disabled (input voltage is under UVLO or enable off), the discharge path is turned off when \( V_{OUT} < 50\text{mV} \) or it waits for the 50ms maximum timer to pass. This function can also be disabled via the I\(^2\)C.

**Thermal Warning (TSW) and Shutdown (TSD)**

Thermal warning and thermal shutdown prevent the MP8860 from operating at exceedingly high temperatures. When the silicon die temperature exceeds 120°C, the MP8860 sets the OTW bit[D5] to 1. When the temperature falls below its lower threshold (typically 100°C), the OTW bit[D5] is 0.

When the silicon die temperature exceeds 150°C, the entire chip shuts down. When the temperature falls below its lower threshold (typically 130°C), the chip is enabled. This is a non-latch protection.

**I\(^2\)C INTERFACE**

**I\(^2\)C Serial Interface Description**

The I\(^2\)C is a 2-wire, bidirectional, serial interface consisting of a data line (SDA) and a clock line (SCL). The lines are pulled to a bus voltage externally when they are idle. When connecting to the line, a master device generates the SCL signal and device address, and arranges the communication sequence. The MP8860 interface is an I\(^2\)C slave, which supports both fast mode (400kHz) and high-speed mode (3.4MHz). The I\(^2\)C interface adds flexibility to the power supply solution. The output voltage, transition slew rate, and other parameters can be controlled instantaneously via the I\(^2\)C interface. When the master sends the address as an 8-bit value, the 7-bit address should be followed by a 0 or 1 to indicate a write or read operation.

**Start and Stop Conditions**

The start and stop conditions are signaled by the master device, which signifies the beginning and end of an I\(^2\)C transfer. The start condition is defined as the SDA signal transitioning from high to low while the SCL is high. The stop condition is defined as the SDA signal transitioning from low to high while the SCL is high (see Figure 10).

The master then generates the SCL clocks and transmits the device address and the read/write direction bit (r/w) on the SDA line.

**Transfer Data**

Data is transferred in 8-bit bytes by an SDA line. Each byte of data is to be followed by an acknowledge bit.

**I\(^2\)C Update Sequence**

The MP8860 requires a start condition, a valid I\(^2\)C address, a register address byte, and a data byte for a single data update. The MP8860 acknowledges the receipt of each byte by pulling the SDA line low during the high period of a single clock pulse. A valid I\(^2\)C address selects the MP8860. The MP8860 performs an update on the falling edge of the LSB byte. Examples of an I\(^2\)C write and read sequence are shown on page 23.

**I\(^2\)C Start-Up Timing**

The I\(^2\)C function is enabled once \( V_{IN} > \text{UVLO} \) and EN is active. The I\(^2\)C function continues working during OCP, OVP, and thermal shutdown.
Figure 10: Start and Stop Condition

I2C Write Example: Write Single Register

Master to Slave
- A = Acknowledge (SDA = LOW)
- S = Start Condition
- WR Write = 0

Slave to Master
- NA = NOT Acknowledge (SDA = HIGH)
- P = Stop Condition
- RD Read = 1

I2C Write Example: Write Multi Register

Master to Slave
- A = Acknowledge (SDA = LOW)
- S = Start Condition
- SR = Repeat
- WR Write = 0

Slave to Master
- NA = NOT Acknowledge (SDA = HIGH)
- P = Stop Condition
- RD Read = 1

I2C Read Example: Read Single Register

Master to Slave
- A = Acknowledge (SDA = LOW)
- S = Start Condition
- SR = Repeat
- WR Write = 0

Slave to Master
- NA = NOT Acknowledge (SDA = HIGH)
- P = Stop Condition
- RD Read = 1
## I²C REGISTER MAP

<table>
<thead>
<tr>
<th>ADD (HEX)</th>
<th>NAME</th>
<th>R/W</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>00</td>
<td>VOUT_L</td>
<td>r/w</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>01</td>
<td>VOUT_H</td>
<td>r/w</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>02</td>
<td>VOUT_GO</td>
<td>r/w</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>03</td>
<td>IOUT_LIM</td>
<td>r/w</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>04</td>
<td>CTL1</td>
<td>r/w</td>
<td>EN*</td>
<td></td>
<td>HICCUP_OCP_OVP*</td>
<td>DISCHG_EN*</td>
<td>MODE*</td>
<td>FREQ</td>
<td></td>
<td></td>
</tr>
<tr>
<td>05</td>
<td>CTL2</td>
<td>r/w</td>
<td></td>
<td></td>
<td>LINE DROP COMP*</td>
<td>SS*</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>06</td>
<td>RESERVED</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>07</td>
<td>RESERVED</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>08</td>
<td>RESERVED</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>09</td>
<td>Status</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0A</td>
<td>Interrupt</td>
<td>W1C</td>
<td>OTEMPPENTER</td>
<td>OTEMPP_EXIT</td>
<td>WARNING_ENTER</td>
<td>OTWARNING_ENTER</td>
<td>OC_ENTER</td>
<td>OC_RECOVER</td>
<td>UVP_FALLING</td>
<td>OTEMPP_EXIT</td>
</tr>
<tr>
<td>0B</td>
<td>Mask</td>
<td>r/w</td>
<td>RESERVED</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0C</td>
<td>ID1</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>27</td>
<td>MFR_ID</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>28</td>
<td>DEV_ID</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>29</td>
<td>IC_REV</td>
<td>r</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**NOTE:**

* These items have one-time programmable (OTP) non-volatile memory. The OTP is reloaded to the I²C register during V<sub>IN</sub> > UVLO or EN shutdown.
REGISTER DESCRIPTION

\textbf{I²C Bus Slave Address}

A resistor-divider from VCC to GND can achieve an accurate reference voltage. Connect ADD to this reference voltage to set different I²C addresses. The internal circuit changes the I²C address accordingly. Table 1 shows the four voltage thresholds for the four I²C addresses and recommended setting resistors.

\begin{table}[h]
\centering
\begin{tabular}{|c|c|c|c|c|}
\hline
\textbf{ADD Voltage} & \textbf{ADD Upper Resistor R4 (kΩ)} & \textbf{ADD Lower Resistor R5 (kΩ)} & \textbf{I²C Address} \\
\hline
<25\%Vcc & No connection & No connection & 1101 001 69H \\
25\%Vcc-50\%Vcc & 499 & 301 & 1101 011 6BH \\
50\%Vcc-75\%Vcc & 301 & 499 & 1101 101 6DH \\
>75\%Vcc & 100 & No connection & 1101 111 6FH \\
\hline
\end{tabular}
\caption{I²C Address Setting via ADD Voltage}
\end{table}

\textbf{VOUT Setting}

The registers VOUT_L and VOUT_H set the output voltage and follow the 11-bit direct format below.

\begin{table}[h]
\centering
\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline
\textbf{Name} & \multicolumn{11}{|c|}{\textbf{VOUT}} \\
\cline{2-12}
\textbf{Register Name} & \textbf{Format} & \textbf{N/A} & \textbf{VOUT_H D[7:0]} & \textbf{VOUT_L D[2:0]} \\
\hline
\textbf{Bit} & \textbf{N/A} & r/w & r/w & r/w & r/w & r/w & r/w & r/w & r/w & r/w & r/w & r/w & r/w \\
\hline
\textbf{Access} & \textbf{N/A} & Data bit high & Data bit low & \\
\hline
\textbf{Function} & \textbf{N/A} & & & \\
\hline
\textbf{Default Value (SV)} & \textbf{N/A} & 500 Integer & \\
\hline
\end{tabular}
\caption{I²C Address Setting via ADD Voltage}
\end{table}

The output voltage can be calculated with Equation (1):

\[ \text{Vout (V)} = \frac{V}{100} \quad (1) \]

Where \( V \) is an 11-bit unsigned binary integer of VOUT[10:0], and \( V \) ranges from 0 to 2047. The VOUT resolution is 10mV/LSB.

Inside the MP8860, there is a feedback resistor network from OUT to the internal FB reference voltage. The feedback resistor ratio is \( VOUT/VFB = 12.5 \). The output voltage change slew rate is fixed at 1mV/µs. Refer to the GO_BIT bit when implementing the output voltage change.

\textbf{VOUT_GO Register}

\textbf{GO_BIT D[0]}

The MP8860 can be controlled when VOUT begins to change. Set GO_BIT to 1 to start the output change based on the VOUT register. When the VOUT change is complete (internal VREF steps to the goal of VREF), GO_BIT auto-resets to 0. This prevents false operation of the VOUT scaling.

Write the output voltage (0x00 and 0x01 registers) first, and then write GO_BIT = 1. VOUT changes based on the new register setting. GO_BIT resets to 0 when VOUT reaches a new value. The host can read GO_BIT to determine if the VOUT scaling is finished or not.

The VOUT-to-ground discharge function is enabled when GO_BIT is 1. This can help ramp VOUT from high to low in a light-load condition.

When GO_BIT is 0, VOUT will not change. When GO_BIT is 1, VOUT changes based on the VOUT register setting. After VOUT scaling finishes, GO_BIT is reset to 0 automatically.
PG_DELAY_EN D[1]
When PG_DELAY_EN D[1] is 0, there is no delay on PG. When PG_DELAY_EN D[1] is 1, PG experiences a 100µs rising delay. The default value is 0.

IOUT_LIM Register
Set the output current limit threshold.

<table>
<thead>
<tr>
<th>Name</th>
<th>IOUT_LIM</th>
</tr>
</thead>
<tbody>
<tr>
<td>Format</td>
<td>Direct, unsigned binary integer</td>
</tr>
<tr>
<td>Bit</td>
<td>7  6  5  4  3  2  1  0</td>
</tr>
<tr>
<td>Access</td>
<td>N/A  r/w  r/w  r/w  r/w  r/w  r/w  r/w</td>
</tr>
<tr>
<td>Default Value (2A)</td>
<td>N/A</td>
</tr>
</tbody>
</table>

IOUT_OC can be calculated with Equation (2):

\[
I_{OUT\_OC} \ (A) = I_{OUT\_LIM} \times 0.05 \tag{2}
\]

Where IOUT_LIM is a 7-bit unsigned binary integer of IOUT_LIM D[6:0]. The IOUT_OC resolution is 50mA/LSB (maximum value is 3A or 0x3C).

The OC pin-to-ground resistor should be 21.5kΩ when using the above IOUT_LIM register. A 22nF (C6) filter capacitor should be added on OC to keep the CC loop stable. The MP8860 supports the I2C setting IOUT_LIM directly. If the CC threshold needs to be changed dynamically after the MP8860 has already entered the CC-limit operation state, it is recommended to change the CC threshold step-by-step (e.g. 50mA per step) instead of changing the current value to the final value directly.

CTL1 Register

<table>
<thead>
<tr>
<th>Name</th>
<th>Bits</th>
<th>Default</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>EN</td>
<td>D[7]</td>
<td>1</td>
<td>I2C controlled turn-on or turn-off of the part. When the external EN pin is low, the converter is off, and the I2C shuts down. When EN is high, the EN bit takes over. 1: Part is turned on. Default. 0: Part is turned off. I2C register does not reset.</td>
</tr>
<tr>
<td>HICCUP_OCP_OVP</td>
<td>D[6]</td>
<td>1</td>
<td>Over-current and over-voltage protection mode selection. 1: Hiccup mode 0: Latch-off mode</td>
</tr>
<tr>
<td>DISCHG_EN</td>
<td>D[5]</td>
<td>1</td>
<td>Output discharge enable bit. 1: Output discharge function during EN or VIN shutdown. 0: No discharge output during shutdown.</td>
</tr>
<tr>
<td>MODE</td>
<td>D[4]</td>
<td>1</td>
<td>Default is PWM mode for light load. 0: Enables auto PFM/PWM mode. 1: Sets forced PWM mode.</td>
</tr>
<tr>
<td>FREQ</td>
<td>D[3:2]</td>
<td>00</td>
<td>Sets the switching frequency. 00: 500kHz 01, 10, 11: reserved</td>
</tr>
</tbody>
</table>
### CTL2 Register

<table>
<thead>
<tr>
<th>Name</th>
<th>Bits</th>
<th>Default</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>LINE DROP</td>
<td>D[7:6]</td>
<td>00</td>
<td>Sets the output voltage compensation vs. the load feature.</td>
</tr>
<tr>
<td>COMP</td>
<td></td>
<td></td>
<td><strong>00: No compensation</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>01: $V_{OUT}$ compensates 50mV @ $I_{OUT}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>10: $V_{OUT}$ compensates 100mV @ $I_{OUT}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>11: $V_{OUT}$ compensates 200mV @ $I_{OUT}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>The above compensation amplitude is fixed for any output voltage. Line drop compensation is only enabled for $V_{OUT}$ 5V and above.</td>
</tr>
<tr>
<td>SS</td>
<td>D[5:4]</td>
<td>11</td>
<td>Sets the output start-up soft-start timer (from 0 to 100%). For 5V output voltage:</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td><strong>00: 300µs</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td><strong>01: 500µs</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td><strong>10: 700µs</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td><strong>11: 900µs</strong></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>The SS slew rate is constant but changes for different $V_{OUT}$ values.</td>
</tr>
</tbody>
</table>

### Status Register

<table>
<thead>
<tr>
<th>Name</th>
<th>Bits</th>
<th>Default</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>0: Output power is not good.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1: Output power is good.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0: Normal state.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1: Chip is in over-temperature protection state.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0: Normal state.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1: Chip is in-over temperature warning state.</td>
</tr>
<tr>
<td>CC_CV</td>
<td>D[4]</td>
<td>X</td>
<td>The chip works in constant-current output mode or constant-voltage output mode.</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0: CV mode</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>1: CC mode</td>
</tr>
</tbody>
</table>

### Interrupt Register

<table>
<thead>
<tr>
<th>Name</th>
<th>Bits</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>OTEMPP_ENTER</td>
<td>D[7]</td>
<td>Over-temperature protection entry indication. When this bit is high, the IC enters thermal shutdown. This bit is not masked, even if setting OTPMSK = 1. OTPMSK = 1 only masks the interrupt pin's output (ALT).</td>
</tr>
<tr>
<td>OTWARNING_ENTER</td>
<td>D[6]</td>
<td>Die temperature early warning entry bit. When this bit is high, the die temperature is higher than 120°C. This bit is not masked, even if setting OTWMSK = 1. OTWMSK = 1 only masks the interrupt pin's output (ALT).</td>
</tr>
<tr>
<td>OC_ENTER</td>
<td>D[5]</td>
<td>Entry of OC or CC current-limit mode. The OC_MSK bit can enable or disable OC_ENTER and OC_RECOVER alert output.</td>
</tr>
<tr>
<td>UVP_FALLING</td>
<td>D[3]</td>
<td>Output voltage is in under-voltage protection.</td>
</tr>
<tr>
<td>OTEMPP_EXIT</td>
<td>D[2]</td>
<td>Over-temperature protection exit. OTPMSK can mask off the ALT of this bit.</td>
</tr>
<tr>
<td>OTWARNING_EXIT</td>
<td>D[1]</td>
<td>Die temperature early warning exit bit. When the die temperature is lower than 100°C, this bit is set to 1. This bit is not masked, even if setting OTWMSK = 1. OTWMSK = 1 only masks the interrupt pin's output (ALT).</td>
</tr>
<tr>
<td>PG_RISING</td>
<td>D[0]</td>
<td>Output power good rising edge.</td>
</tr>
</tbody>
</table>

These status bits indicate instantaneous value.
<table>
<thead>
<tr>
<th>Name</th>
<th>Bits</th>
<th>Default</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>OTPMSK</td>
<td>D[4]</td>
<td>0</td>
<td>SET OTPMSK = 1 to mask off the OTP alert. OTPMSK = 1 only masks the interrupt pin’s output (ALT). This is not the interrupt register, but is similar for other mask bits.</td>
</tr>
<tr>
<td>OTWMSK</td>
<td>D[3]</td>
<td>0</td>
<td>Masks off the over-temperature warning.</td>
</tr>
<tr>
<td>OC_MSK</td>
<td>D[2]</td>
<td>0</td>
<td>Masks off both OC/CC entry and recovery.</td>
</tr>
<tr>
<td>UVP_MSK</td>
<td>D[1]</td>
<td>0</td>
<td>Masks off the output UVP interrupt.</td>
</tr>
<tr>
<td>PG_MSK</td>
<td>D[0]</td>
<td>0</td>
<td>Masks off the PG indication function on ALT.</td>
</tr>
</tbody>
</table>

- **PG_MSK**
  - 0xFF to OA reg can reset ALT pin
- **OTEMPP_ENTER**
- **OTWARNING_ENTER**
- **OC_ENTER**

**Figure 11: ALT Behavior of OTP, OT Warning, and OC Recovery**
APPLICATION INFORMATION

Component Selection

Program the Constant Current (CC) Limit Threshold (CC Limit Range: 1A to 3A)

There are two methods to set the MP8860 constant current limit threshold. One is through \(\text{I}^2\text{C}\); the other way is through an external \(R_{\text{OC}}\) resistor.

When the \(\text{I}^2\text{C}\) function is not in use, the \(R_{\text{OC}}\) resistor value can be changed to program the CC current limit threshold. In general, the MP8860 CC current limit value should be higher than the normal maximum load current, allowing the tolerances in the current sense value. The current limit can be set using Equation (1):

\[
R_{\text{SET}}(\text{k}\Omega) = \frac{42.9}{I_{\text{Limit(A)}}} (1)
\]

Equation (1) provides the theory result.

Selecting the Inductor

In a buck-boost topology circuit, the inductor must support buck applications with the maximum input voltage and boost applications with the minimum input voltage. Two critical inductance values can be determined according to the buck mode and boost mode current ripple using Equation (2) and Equation (3):

\[
L_{\text{MIN-BUCK}} = \frac{V_{\text{OUT}} \times (V_{\text{IN(MAX)}} - V_{\text{OUT}})}{V_{\text{IN(MAX)}} \times F_{\text{REQ}} \times \Delta I_L} (2)
\]

\[
L_{\text{MIN-BOOST}} = \frac{V_{\text{IN(MIN)}} \times (V_{\text{OUT}} - V_{\text{IN(MIN)}})}{V_{\text{OUT}} \times F_{\text{REQ}} \times \Delta I_L} (3)
\]

Where \(F_{\text{REQ}}\) is the switching frequency, and \(\Delta I_L\) is the peak-to-peak inductor current ripple. As a rule of thumb, the peak-to-peak ripple can be set to 0.5A to 1.5A. The minimum inductor value for the application is the higher value from the results of Equation (2) and Equation (3).

In addition to the inductance value, the inductor must support the peak current based on Equation (4) and Equation (5) to avoid saturation:

\[
I_{\text{PEAK-BUCK}} = I_{\text{OUT}} + \frac{V_{\text{OUT}} \times (V_{\text{IN(MAX)}} - V_{\text{OUT}})}{2 \times V_{\text{IN(MAX)}} \times F_{\text{REQ}} \times L} (4)
\]

\[
I_{\text{PEAK-BOOST}} = \frac{V_{\text{OUT}} \times I_{\text{OUT}}}{\eta \times V_{\text{IN(MIN)}}} + \frac{V_{\text{IN(MIN)}} \times (V_{\text{OUT}} - V_{\text{IN(MIN)}})}{2 \times V_{\text{OUT}} \times F_{\text{REQ}} \times L} (5)
\]

Where \(\eta\) is the estimated efficiency of the MP8860.

Input and Output Capacitor Selection

It is recommended to use ceramic capacitors plus an electrolytic capacitor for input and output capacitors to filter the input and output ripple current and achieve stable operation.

Since the input capacitor absorbs the input switching current, it requires sufficient capacitance. For most applications, a 100\(\mu\)F electrolytic capacitor and a 22\(\mu\)F ceramic capacitor are sufficient.

The output capacitor stabilizes the DC output voltage. Low ESR capacitors and a sufficient capacitor value are recommended to limit the output voltage ripple. A 100\(\mu\)F low ESR (\(\leq 80m\Omega\)) aluminum electrolytic, or polymer capacitor and two 10\(\mu\)F ceramic capacitors, are recommended.

The input and output ceramic capacitors should be placed as close as possible to the device.
PCB Layout Guidelines

Efficient PCB layout is critical for stable operation and thermal dissipation. For best results, refer to Figure 12 and follow the guidelines below.

1. Place the ceramic $C_{\text{IN}}$ and $C_{\text{OUT}}$ capacitor close to the IC’s $V_{\text{IN}}$-to-GND and OUT-to-GND pins, respectively.
2. Use a large copper plane for PGND.
3. Add multiple vias to improve thermal dissipation.
4. Connect AGND to PGND.
5. Use short, direct, and wide traces to connect OUT.
6. Add vias under the IC and route the OUT trace on both PCB layers (highly recommended).
7. Use a large copper plane for SW1 and SW2.
8. Place the VCC decoupling capacitor as close to VCC as possible.

NOTES:

9) The recommended layout is based on the typical application circuit in Figure 13.
TYPICAL APPLICATION CIRCUITS

Figure 13: Typical Application Circuit for 1 - 20V_{OUT}
NOTE: Refer to the recommended maximum I_{OUT} vs. V_{IN} and V_{OUT} with 120μF low ESR C_{OUT} capacitor curve on page 9.
PACKAGE INFORMATION

QFN-16 (3mmx3mm)

TOP VIEW

BOTTOM VIEW

SIDE VIEW

NOTE:
1) THE LEAD SIDE IS WETTABLE.
2) ALL DIMENSIONS ARE IN MILLIMETERS.
3) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
4) JEDEC REFERENCE IS MO-220.
5) DRAWING IS NOT TO SCALE.

RECOMMENDED LAND PATTERN

NOTICE: The information in this document is subject to change without notice. Please contact MPS for current specifications. Users should warrant and guarantee that third-party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.